

PATENT ASSIGNMENT

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NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
Name		Execution Date
Jung Hwa Jung		01/03/2008
RECEIVING PARTY DATA		
Name:	SEOUL SEMICONDUCTOR CO., LTD.	
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PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	11995196	
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Total Attachments: 2		
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PATENT
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ASSIGNMENT

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Assignee: U.S. PATENT AND TRADE OFFICE, INC.

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Title of
Invention.

MOLD FOR FORMING A MOLDING MEMBER AND
METHOD OF FABRICATING A MOLDING MEMBER
USING THE SAME

U.S. Patent Application:

Application Serial No.: Not yet assigned

Filing Date: Herewith

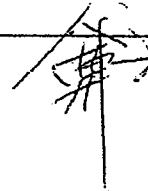
For good and valuable consideration, the receipt of which is hereby acknowledged, the above-named Assignor hereby sells, assigns and transfers to Assignee, the full and exclusive right, title and interest in and to the above-identified invention, patent application and patent rights throughout the world, including foreign patent priority rights; said invention, application and letters patent in this or any foreign country, and all divisions, continuations, reissues, non-provisionals and extensions thereof, to be held and enjoyed by Assignee, for its own use and benefit, and for its successors and assigns to the full end of the term for which letters patent may be granted in this or any foreign country, as fully and entirely as the same would have been held by Assignor had this assignment and sale not been made, and covenant that Assignor has full right so to do, and agree that Assignor will communicate to Assignee, or its successors and assigns, any facts known to Assignor respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, non-provisional and reissue applications, make all rightful oaths, and do everything possible to aid Assignee, its successors and assigns to obtain and enforce proper patent protection for said invention in this or any foreign country.

Our Docket No.: 1226-031
Your Ref. No.: P06-5011/US

In the event that the patent application filing date or serial number is not known at the time this document is executed, Assignor hereby grants permission to the attorneys of record in the patent application to fill in the filing date and/or serial number above, and to record this assignment after such information is added.

Executed at this 3 day of Jan, 2008.

Jung Hwa JUNG
Assignor

A handwritten signature in black ink, appearing to be 'Jung Hwa JUNG', is written over a horizontal line. The signature is stylized and includes a vertical line extending downwards from the end of the horizontal line.